# **LEVEL 2**

**CO-ORGANIZED BY** 

# LABORATORY TRAINING ON







SEMICONDUCTOR PACKACING

2024

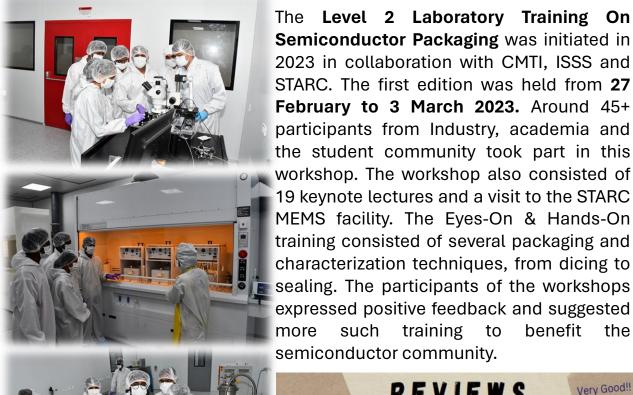
**DATES:** 06 to 09, JULY 2024

WRITE TO: CSVTC.CMTI@GMAIL.COM

CONTACT



**CMTI** Bengaluru





This training will include expert talks and lectures from leading industry professionals and experienced academic faculty. It covers the latest trends and recent advancements in advanced packaging technologies with future prospectives

Why this workshop?

What will be covered?

#### **EYES-ON & HANDS-ON PROCESSES**

Wafer dicing
Wire bonding
Bond testing
Flip chip bonding
Leak testing

Wafer bonding
Electroplating
E-beam welding
Elec.

Characterization

#### **COURSE FEE\***

Industry: 30000 INR R&D/Faculty: 20000 INR Students: 10000 INR

\* Exclusive of GST | GST: 18% Extra

#### **FOR ISSS MEMBERS\***

Industry: 25000 INR

R&D/Faculty: 15000 INR

Students: 8000 INR

Fee?

Register?

## REGISTRATION



## PAYMENT

